Innovating Energy Technology

FMP60N125S2HF

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FUJI POWER MOSFET

Super J MOS® S2 series

N-Channel enhancement mode power MOSFET

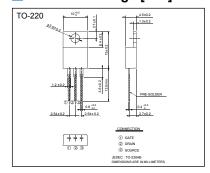
Features

Pb-free lead terminal RoHS compliant uses Halogen-free molding compound

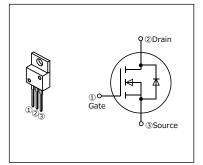
Applications

For switching

Outline Drawings [mm]



Equivalent circuit schematic



■ Absolute Maximum Ratings at T_{vi}=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Course Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Drain Current	I _D	30.1	Α	T _{vj} =25°C Note*1,2
Continuous Drain Current		19	Α	T _{vj} =100°C Note*1,2
Pulsed Drain Current	I DP	90.8	Α	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	I AS	3.5	А	Note *3
Non-Repetitive Maximum Avalanche Energy	E as	748	mJ	Note *4
Maximum Drain-Source dV/dt	d <i>V</i> ⊳s/dt	50	V/ns	V _{DS} ≤ 600V
Continuous	,	30.1	Α	<i>T</i> _{vj} =25°C Note*1,2
Diode Forward Current	I sd	19	Α	T _{vj} =100°C Note*1,2
Pulsed Diode Forward Current	I SDP	90.8	Α	Note *2
Peak Diode Recovery dV/dt	dV/dt	15	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
	Po	2.02	W	<i>T</i> _a =25°C
Maximum Power Dissipation	F □	160	VV	<i>T</i> _c =25°C
Oneveting and Stayons Townsystems rooms	T _{ch}	150	°C	
Operating and Storage Temperature range	\mathcal{T}_{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.65

Note *1: Imited by maximum channel temperature. Note *3: $T_{ch} \leq 150^{\circ}$ C, See Fig.1 and Fig.2 Note *3: $T_{ch} \leq 150^{\circ}$ C, See Fig.1 and Fig.2 Note *4: Starting $T_{ch} = 25^{\circ}$ C, $I_{as} = 2.14$, $I_{ch} = 311$ mHH, $V_{DD} = 60$ V, $R_{ch} = 50\Omega$, See Fig.1 and Fig.2 Eas limited by maximum channel temperature and avalanche current. Note *5: $I_{SD} \leq 22.74$, $I_{ch} \leq 100$ A/ $I_{sh} \leq 1000$ A/ $I_{sh} \leq 1000$ A/ $I_{sh} \leq 10$

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■ Electrical Characteristics at *T*_{vj}=25°C (unless otherwise specified) • Static Ratings

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{ss} =0V I _b =250μA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =1.22mA		3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	I oss	V _{DS} =600V V _{GS} =0V	<i>T</i> _{ch} =25°C	-	-	25	μА
		V _{DS} =480V V _{GS} =0V	<i>T</i> _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	I GSS	V _{DS} =0V V _{GS} = ± 30V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V I _D =11.4A		-	0.114	0.125	Ω
Gate resistance	R _G	f=1MHz, open drain		-	8.3	_	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g fs	V _{DS} =25V I _D =11.4A	7.5	15	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	1240	-	
Output Capacitance	Coss	V _{GS} =0V	-	42	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	6.3	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} =0400V V _{GS} =0V	-	102	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	V _{DS} =0400V V _{GS} =0V I _D =constant	-	391	-	
Turn-On Time	t _{d(on)}	V_{DD} =400V, V_{GS} =10V I_D =11.4A, R_G =15Ω See Fig.3 and Fig.4	-	21	-	
Turn-On Time	t r		-	78	-	ns
Turn-Off Time	t _{d(off)}		-	101	-	110
Turn-On Time	t f		-	24	-	
Total Gate Charge	Q _G		-	53	-	
Gate-Source Charge	Q _{GS}	V _{DD} =400V, V _{GS} =10V I _D =22.7A See Fig.5	-	20	-	nC
Gate-Drain Charge	Q _{GD}		-	20	-	nC
Drain-Source crossover Charge	Qsw		-	13	-	

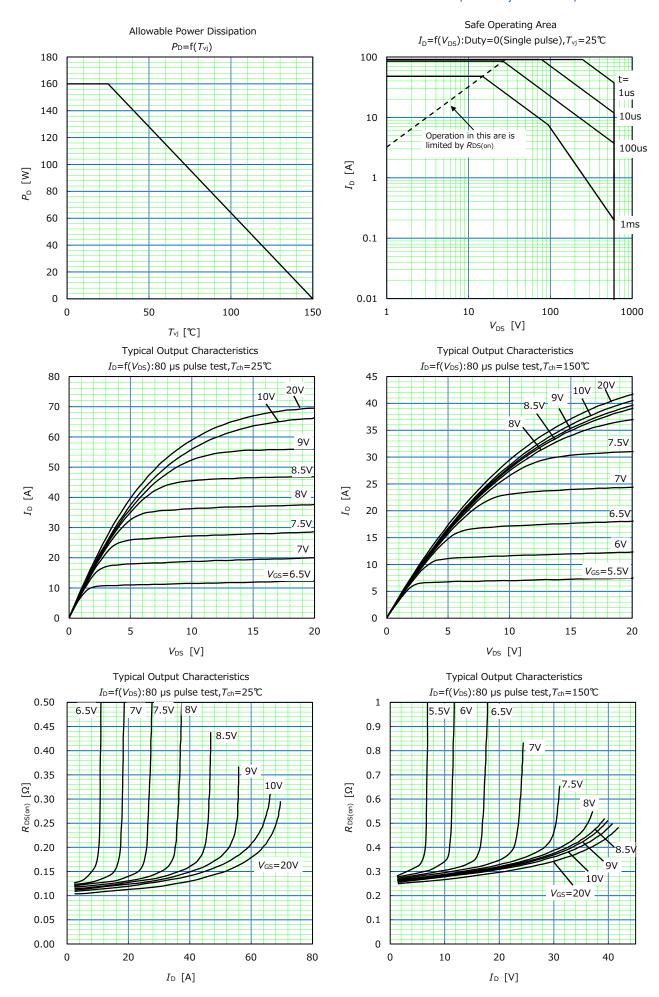
Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{Ds} is rising from 0 to 400V. Note *8 : $C_{o(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{Ds} is rising from 0 to 400V.

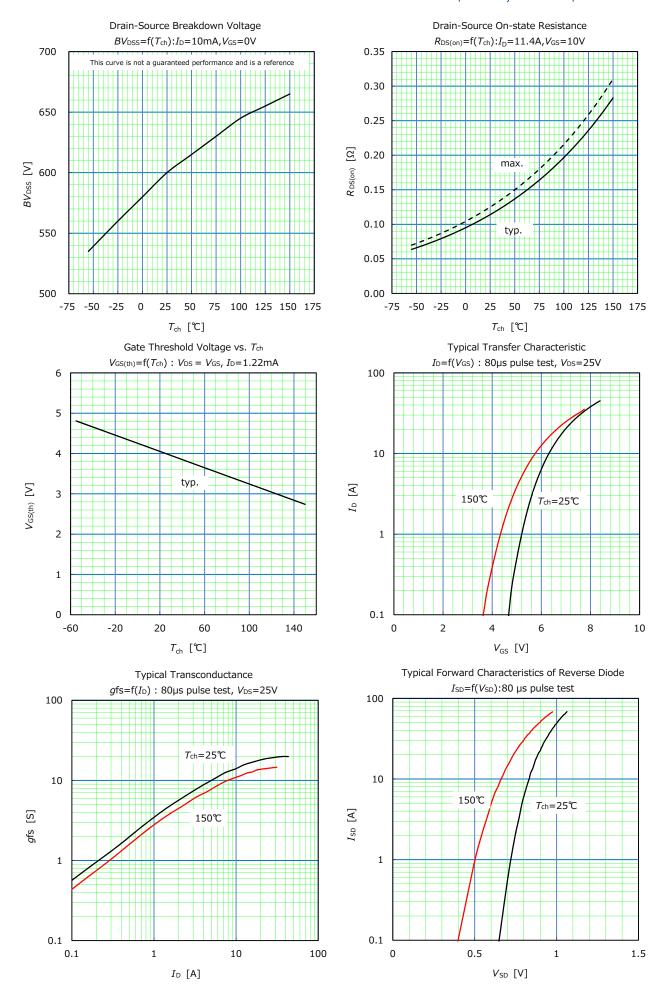
Reverse Diode

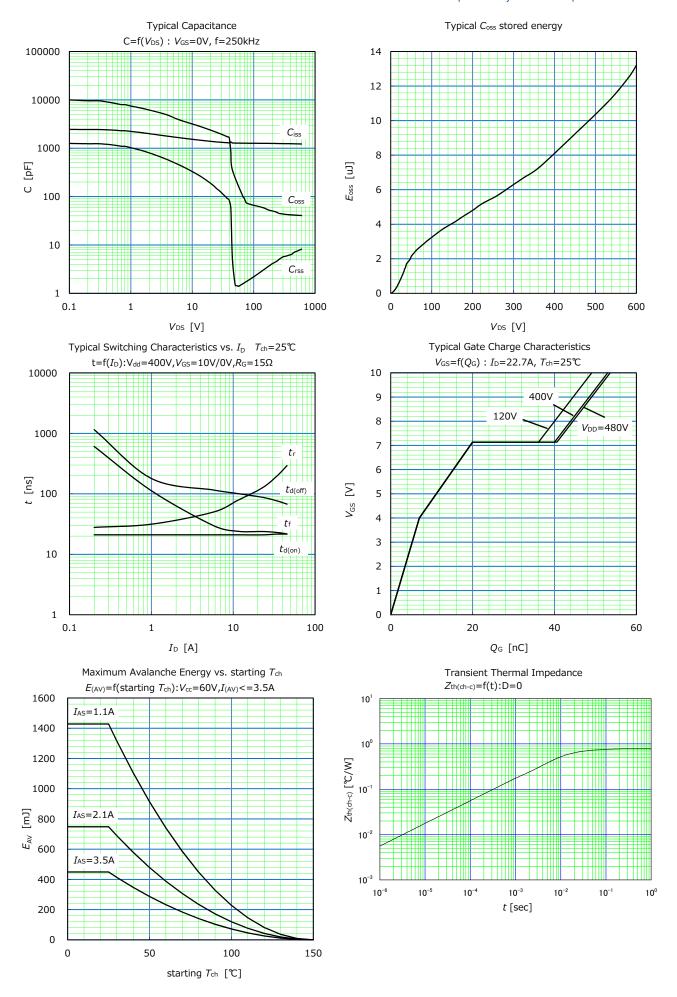
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{SD}	I _{SD} =22.7A, V _{GS} =0V T _{Ch} =25°C	-	0.90	1.35	V
Reverse Recovery Time	t rr	- V _{DD} =400V, I _{SD} =22.7A -di/dt=100A/μs Τ _{ch} =25°C See Fig.6 and Fig.7	1	310	1	ns
Reverse Recovery Charge	Qrr		-	4.4	-	μC
Peak Reverse Recovery Current	I rp		-	27	-	Α

■ Thermal Resistance

Parameter	Symbol	Min.	Тур.	Max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.781	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	62	°C/W







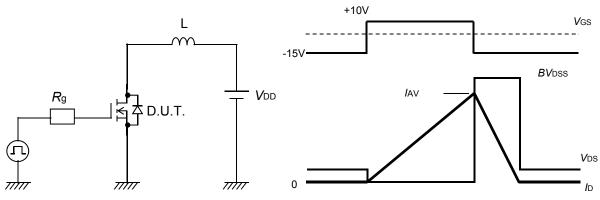


Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test

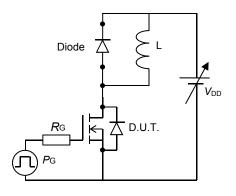


Fig.3 Switching Test circuit

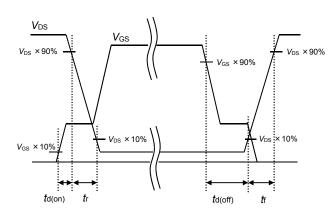


Fig.4 Operating waveform of Switching Test

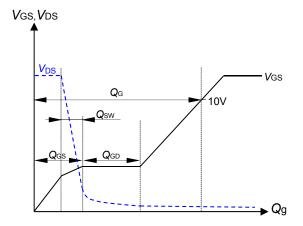


Fig.5 Operating waveform of Gate charge Test

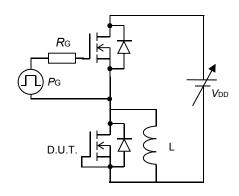


Fig.6 Reverse recovery Test circuit

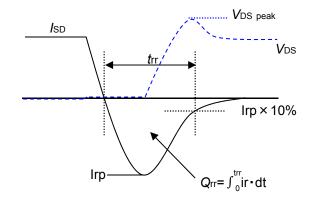
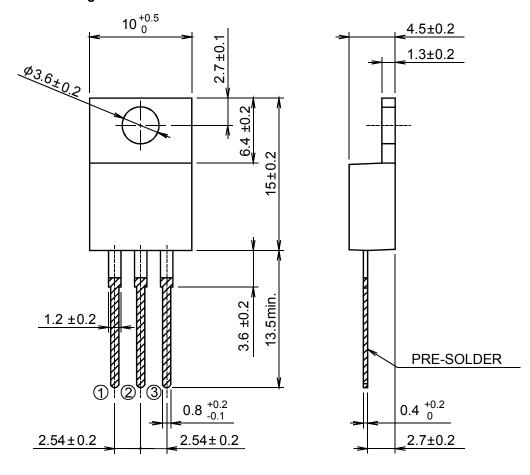
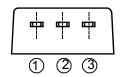


Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-220 Package





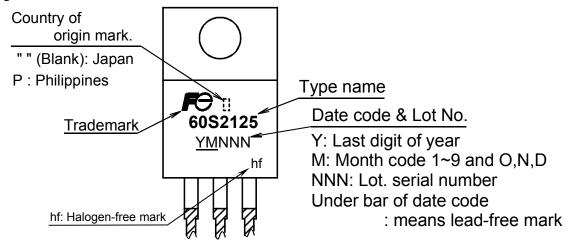
CONNECTION

- 1 GATE
- 2 DRAIN
- 3 SOURCE

JEDEC: TO-220AB

DIMENSIONS ARE IN MILLIMETERS.

Marking



* The font (font type, size) and the trademark-size might be actually different.

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